

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit
V_{PP}	Peak pulse voltage	IEC 61000-4-2 ($C = 150\text{ pF}$, $R = 330\text{ }\Omega$)	kV
	Contact discharge	30	
	Air discharge	30	
P_{PP}	Peak pulse power dissipation	$T_j \text{ initial} = T_{amb}$	W
T_{stg}	Storage temperature range	-65 to +150	$^{\circ}\text{C}$
T_j	Operating junction temperature range	-55 to +150	$^{\circ}\text{C}$
T_L	Maximum lead temperature for soldering during 10 s	260	$^{\circ}\text{C}$

Figure 1. Electrical characteristics - parameter definitions

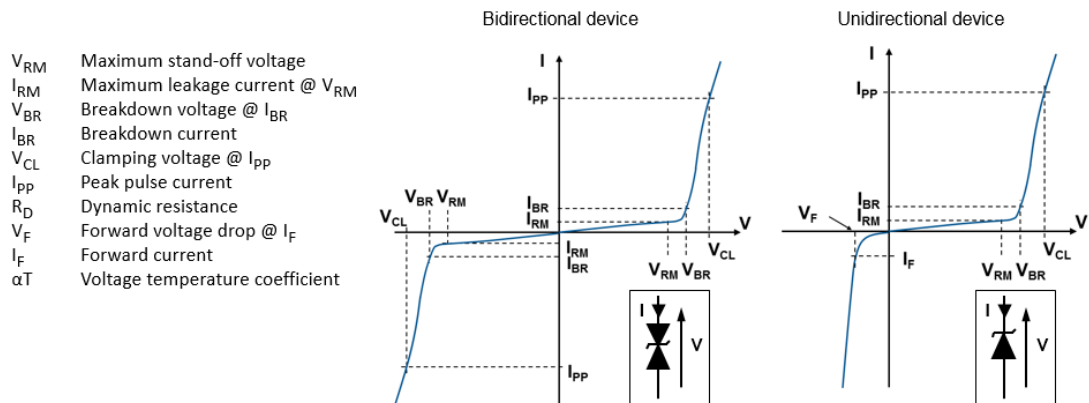


Figure 2. Pulse definition for electrical characteristics

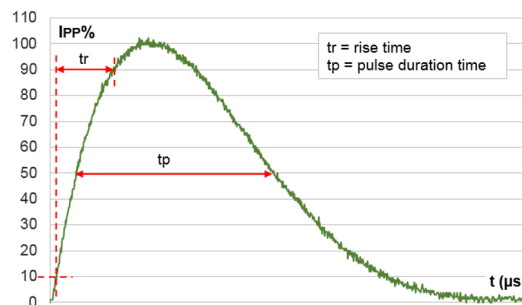


Table 2. Electrical characteristics - parameter values ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Type	I_{RM} max at V_{RM}			V_{BR} at I_R ⁽¹⁾			10 / 1000 μs			8 / 20 μs			αT
							V_{CL} ⁽²⁾⁽³⁾	I_{PP} ⁽⁴⁾	R_D	V_{CL} ⁽²⁾⁽³⁾	I_{PP} ⁽⁴⁾	R_D	
	25 $^{\circ}\text{C}$	85 $^{\circ}\text{C}$		Min.	Typ.		Max.		Max.	Max.		Max.	Max.
	μA		V	V		mA	V	A	Ω	V	A	Ω	$10^{-4}/^{\circ}\text{C}$
SMCJ5.0A/CA	500	2000	5	6.4	6.74	10	9.20	171	0.012	13.4	746	8.5	5.7
SMCJ6.0A/CA	500	2000	6	6.7	7.05	10	10.3	152	0.019	13.7	730	8.6	5.9
SMCJ6.5A/CA	250	1000	6.5	7.2	7.58	10	11.2	140	0.023	14.5	690	9.5	6.1
SMCJ8.5A/CA	10	50	8.5	9.4	9.9	1	14.4	105	0.038	19.5	512	18	7.3
SMCJ10A/CA	0.2	1	10	11.1	11.7	1	17	92	0.051	21.7	461	20	7.8
SMCJ12A/CA	0.2	1	12	13.3	14	1	19.9	79	0.066	25.3	394	27	8.3
SMCJ13A/CA	0.2	1	13	14.4	15.2	1	21.5	73	0.076	27.2	368	31	8.4
SMCJ15A/CA	0.2	1	15	16.7	17.6	1	24.4	64	0.092	32.5	308	46	8.8
SMCJ18A/CA	0.2	1	18	20	21.1	1	29.2	53	0.133	39.3	254	68	9.2
SMCJ20A/CA	0.2	1	20	22.2	23.4	1	32.4	48	0.163	42.8	234	78	9.4
SMCJ22A/CA	0.2	1	22	24.4	25.7	1	35.5	44	0.194	48.3	207	103	9.6
SMCJ24A/CA	0.2	1	24	26.7	28.1	1	38.9	40	0.235	50	200	102	9.6
SMCJ26A/CA	0.2	1	26	28.9	30.4	1	42.1	37	0.275	53.5	187	115	9.7
SMCJ28A/CA	0.2	1	28	31.1	32.7	1	45.4	34	0.325	59	169	146	9.8
SMCJ30A/CA	0.2	1	30	33.3	35.1	1	48.4	32	0.361	64.3	156	176	9.9
SMCJ33A/CA	0.2	1	33	36.7	38.6	1	53.3	29	0.440	69.7	143	204	10.0
SMCJ40A/CA	0.2	1	40	44.4	46.7	1	64.5	24	0.644	84	119	294	10.1
SMCJ48A/CA	0.2	1	48	53.3	56.1		77.4	20	0.925	100	100	411	10.3
SMCJ58A/CA	0.2	1	58	64.4	67.8	1	93.6	16	1.40	121	83	600	10.4
SMCJ70A/CA	0.2	1	70	77.8	81.9	1	113	13.9	1.94	146	69	870	10.5
SMCJ85A/CA	0.2	1	85	94	99	1	137	11.5	2.87	178	56	1322	10.6
SMCJ100A/CA	0.2	1	100	111	117	1	162	9.7	4.04	212	47	1897	10.7
SMCJ130A/CA	0.2	1	130	144	152	1	209	7.5	6.59	265	38	2774	10.8
SMCJ154A/CA	0.2	1	154	171	180	1	246	6.1	9.34	317	31.5	4063	10.8
SMCJ170A/CA	0.2	1	170	189	199	1	274	5.5	11.8	353	28	5145	10.8
SMCJ188A/CA	0.2	1	188	209	220	1	328	4.6	21.1	388	26	6038	10.8

1. To calculate V_{BR} versus T_j : V_{BR} at $T_j = V_{BR}$ at $25\text{ }^{\circ}\text{C} \times (1 + \alpha T \times (T_j - 25))$
2. To calculate V_{CL} versus T_j : V_{CL} at $T_j = V_{CL}$ at $25\text{ }^{\circ}\text{C} \times (1 + \alpha T \times (T_j - 25))$
3. To calculate V_{CL} max versus I_{PP} appli: $V_{CLmax} = V_{CL} - R_D \times (I_{PP} - I_{PPappli})$ where I_{PP} appli is the surge current in the application
4. Surge capability given for both directions for unidirectional and bidirectional devices

1.1 Characteristics curves

Figure 3. Maximum peak power dissipation versus initial junction temperature

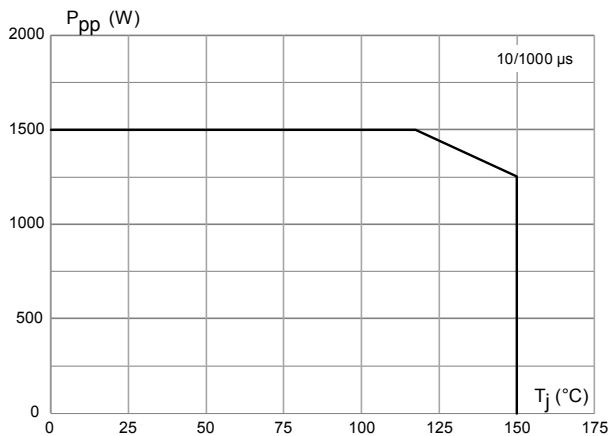


Figure 4. Maximum peak pulse power versus exponential pulse duration

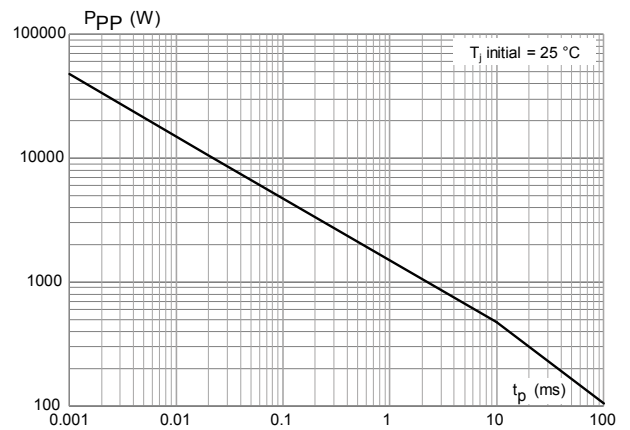


Figure 5. Maximum peak pulse current versus clamping voltage

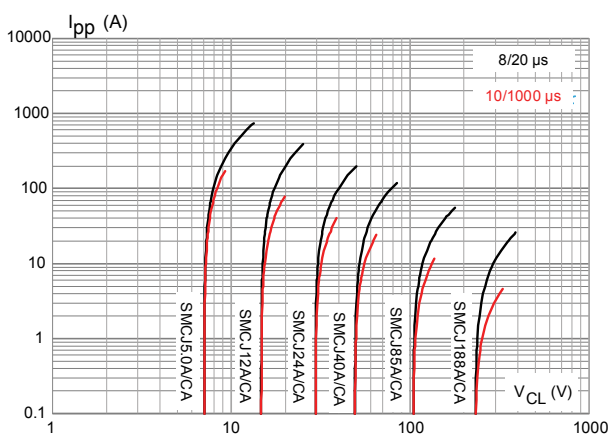


Figure 6. Dynamic resistance versus pulse duration

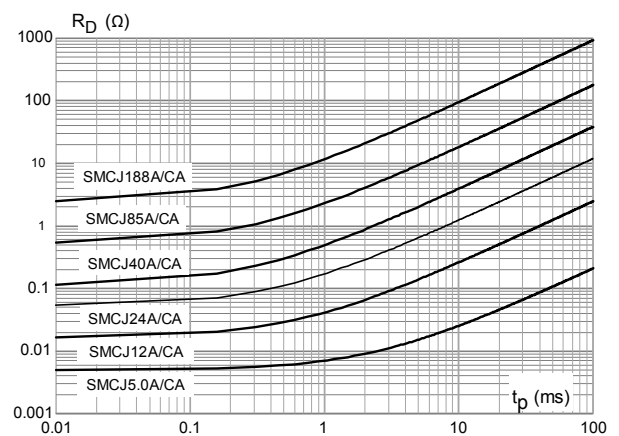
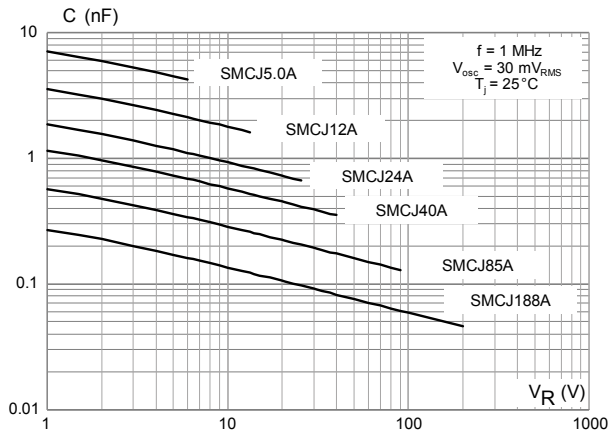
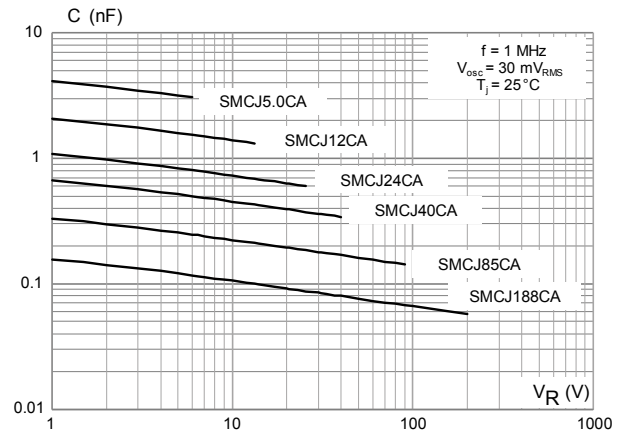
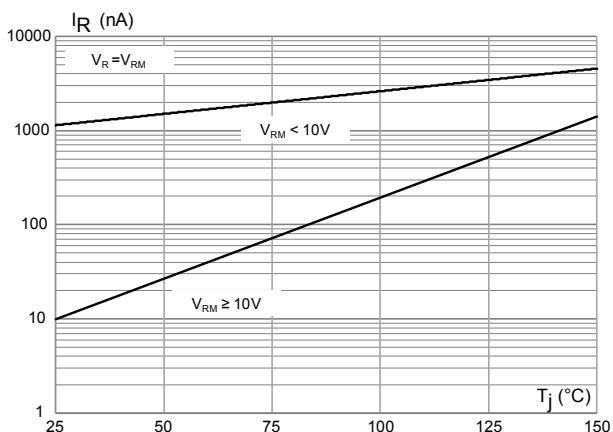
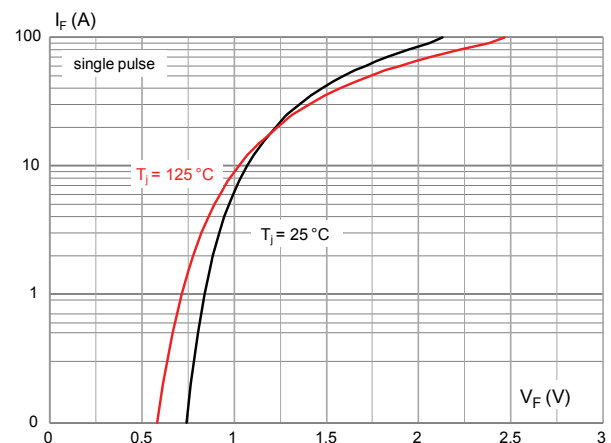
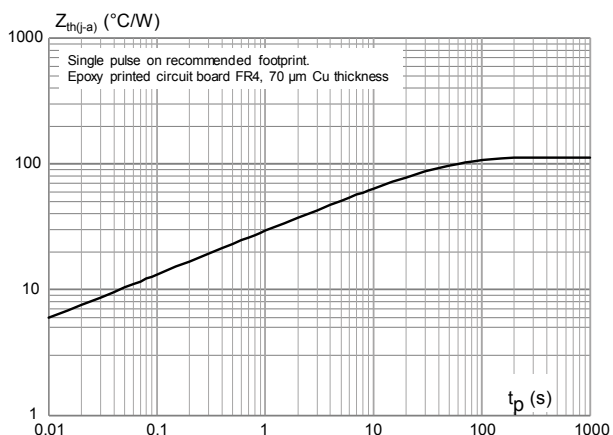
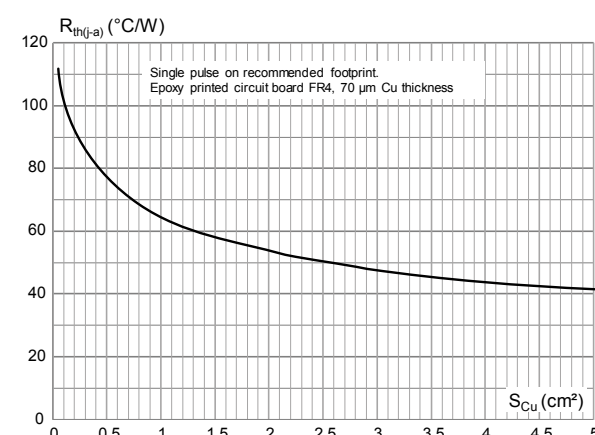


Figure 7. Junction capacitance versus applied voltage (unidirectional type)

Figure 8. Junction capacitance versus applied voltage (bidirectional type)

Figure 9. Leakage current versus junction temperature

Figure 10. Peak forward voltage drop versus peak forward current

Figure 11. Thermal impedance junction to ambient versus pulse duration

Figure 12. Thermal resistance junction to ambient versus copper area under each lead


2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMC package information

- Epoxy meets UL94, V0

Figure 13. SMC package outline

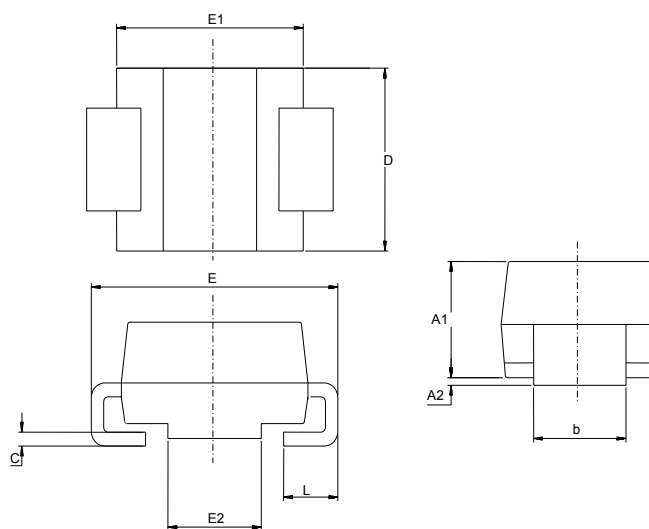


Table 3. SMC package mechanical data

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.40	0.006	0.016
D	5.55	6.25	0.218	0.246
E	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
L	0.75	1.50	0.030	0.060

Figure 14. Footprint recommendation

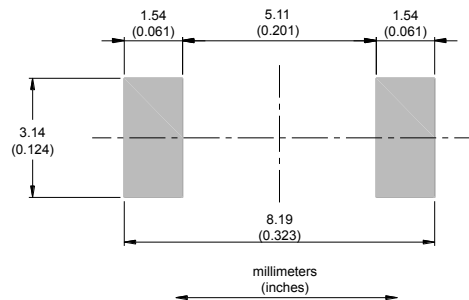


Figure 15. Marking layout

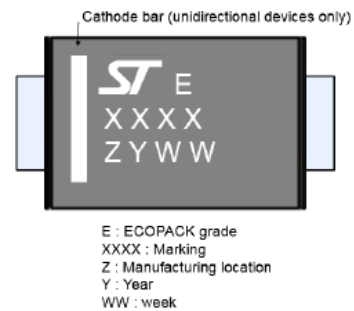
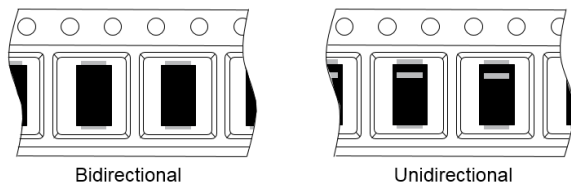


Figure 16. Package orientation in reel



Taped according to EIA-481
Pocket dimensions are not on scale.
Pocket shape may vary depending on package
On bidirectional devices, marking and logo may not be always in the same direction.

Figure 17. Tape and reel orientation

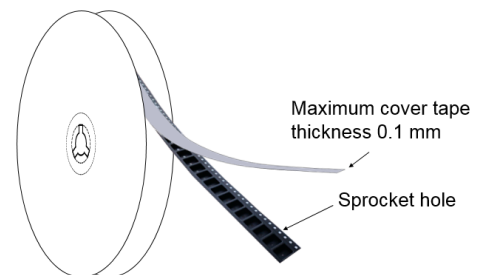


Figure 18. 13" reel dimension values (mm)

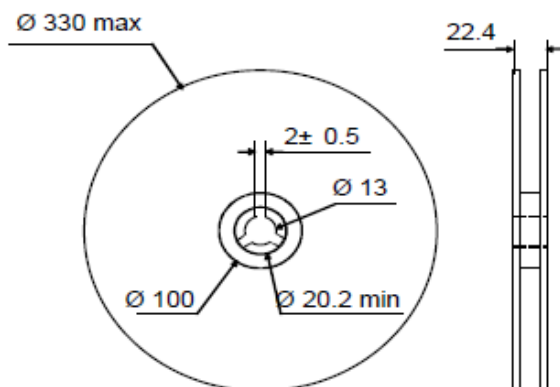


Figure 19. Inner box dimension values (mm)

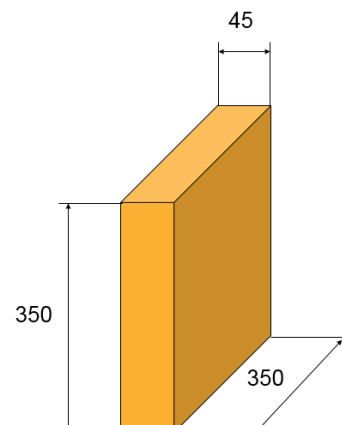
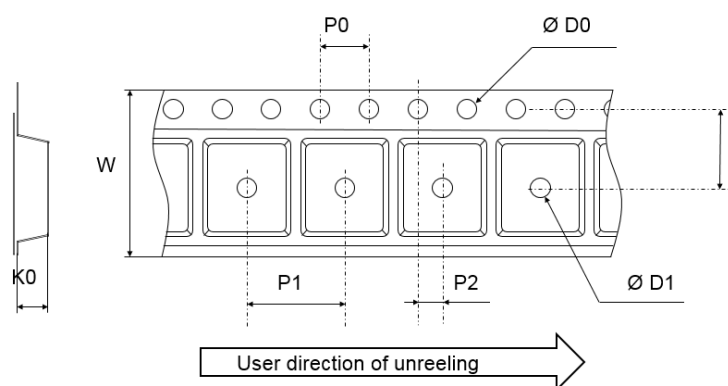


Figure 20. Tape outline



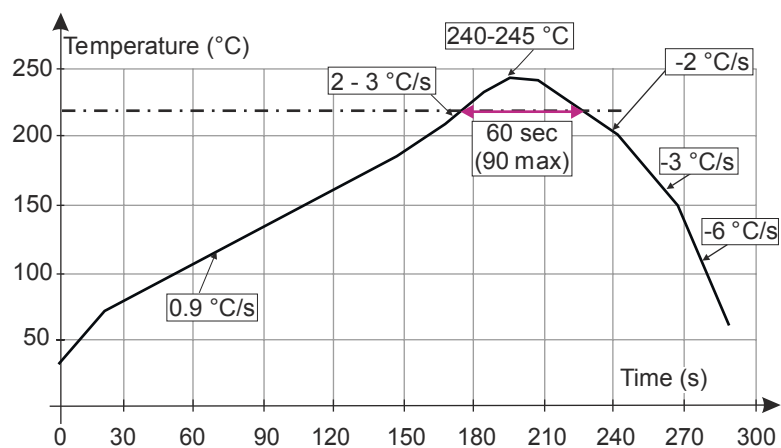
Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package

Table 4. Tape dimension values

Ref.	Dimensions		
	Millimeters		
	Min.	Typ.	Max.
D0	1.4	1.5	1.6
D1	1.5		
F	7.4	7.5	7.6
K0	2.39	2.49	2.59
P0	3.9	4.0	4.1
P1	7.9	8.0	8.1
P2	1.9	2.0	2.1
W	15.7	16	16.3

2.2 Reflow profile

Figure 21. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

3 Application and design guidelines

More information is available in the application note AN2689 “Protection of automotive electronics from electrical hazards, guidelines for design and component selection”.

4 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
SMCJxxA/CA-TR ⁽¹⁾	See Table 6. Marking	SMC	0.25 g	2500	Tape and reel

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version.

Table 6. Marking

Order code	Marking	Order code	Marking
SMCJ5.0A-TR	FUA	SMCJ5.0CA-TR	FBA
SMCJ6.0A-TR	FUB	SMCJ6.0CA-TR	FBB
SMCJ6.5A-TR	FUC	SMCJ6.5CA-TR	FBC
SMCJ8.5A-TR	FUD	SMCJ8.5CA-TR	FBD
SMCJ10A-TR	FUF	SMCJ10CA-TR	FBF
SMCJ12A-TR	FUH	SMCJ12CA-TR	FBH
SMCJ13A-TR	FUI	SMCJ13CA-TR	FBI
SMCJ15A-TR	FUJ	SMCJ15CA-TR	FBJ
SMCJ18A-TR	FUL	SMCJ18CA-TR	FBL
SMCJ20A-TR	FUM	SMCJ20CA-TR	FBM
SMCJ22A-TR	FUN	SMCJ22CA-TR	FBN
SMCJ24A-TR	FUO	SMCJ24CA-TR	FBO
SMCJ26A-TR	FUP	SMCJ26CA-TR	FBP
SMCJ28A-TR	FUQ	SMCJ28CA-TR	FBQ
SMCJ30A-TR	FUR	SMCJ30CA-TR	FBR
SMCJ33A-TR	FUS	SMCJ33CA-TR	FBS
SMCJ40A-TR	FUU	SMCJ40CA-TR	FBU
SMCJ48A-TR	FUW	SMCJ48CA-TR	FBW
SMCJ58A-TR	FUZ	SMCJ58CA-TR	FBZ
SMCJ70A-TR	GUB	SMCJ70CA-TR	GBB
SMCJ85A-TR	GUE	SMCJ85CA-TR	GBE
SMCJ100A-TR	GUG	SMCJ100CA-TR	GBG
SMCJ130A-TR	GUI	SMCJ130CA-TR	GBI
SMCJ154A-TR	GUL	SMCJ154CA-TR	GBL
SMCJ170A-TR	GUM	SMCJ170CA-TR	GBM
SMCJ188A-TR	GUN	SMCJ188CA-TR	GBN

Revision history

Table 7. Document revision history

Date	Version	Changes
August-1999	5	Previous update.
14-May-2009	6	Reformatted to current standards. Updated ECOPACK statement.
17-Sep-2009	7	Document updated for low leakage current.
12-Jul-2010	8	Changed timescale in Figure 9.
03-Feb-2020	9	Minor text changes to improve readability. Updated Table 2. Electrical characteristics - parameter values ($T_{amb} = 25\text{ °C}$, unless otherwise specified) and Section 1.1 Characteristics (curves) .

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